

Chinese Handset Manufacturers Select Conexant's CDMA Power Amplifier Modules

Editorial Contacts:

Gwen Carlson Conexant Systems, Inc. (949) 483-7363 gwen.carlson@conexant.com

Roslyn Whitehurst Benjamin | A Weber Shandwick Company (949) 260-1300 roslyn_whitehurst@benjamingroup.com

CHINESE HANDSET MANUFACTURERS SELECT CONEXANT'S CDMA POWER AMPLIFIER MODULES

Superior Linearity and Efficiency Earn Conexant Status as Primary Provider of CDMA Chipsets for China Unicom's Nationwide Cellular Network

NEWPORT BEACH, Calif., Feb. 26, 2002 - Conexant Systems, Inc. (Nasdaq: CNXT), a global leader in semiconductor system solutions for communications applications, today announced multiple design wins in China for its code division multiple access (CDMA) power amplifier modules (PAMs). These design wins represent 70 percent of the manufacturers approved by the Chinese government. They will be operating on the China United Communications Corporation's (China Unicom) recently launched nationwide CDMA cellular network. The network is expected to support approximately 15 million subscribers by the end of 2002, growing to 50 million subscribers by 2005.

"We're proud that our power amplifiers have been selected by the majority of handset providers for the China Unicom network," said Moiz Beguwala, senior vice president and general manager of Conexant's Wireless Communications Division. "Conexant's history in power amplifiers is marked by a number of industry firsts, and it is an honor to have earned the distinction of being the primary supplier of CDMA power amplifier modules for the launch of the China's nationwide CDMA network."

Conexant is the world's largest supplier of CDMA PAMs, and continues to lead the market in efficiency and linearity. The company's history in power amplifiers dates back to 1996, when the company commenced high-volume shipments supporting multi-band, multi-mode, digital wireless applications. Conexant was also the first to introduce high-volume, laminate-based PAMs used in global system for mobile communications (GSM) and time division multiple access (TDMA) applications. Today, virtually all of Conexant's PA solutions are implemented in modules.

Conexant's PAMs are based on a 50 GHz gallium arsenide (GaAs) heterojunction bipolar transistor (HBT) or GaAs indium gallium phosphide (InGaP) process technology. GaAs is the technology of choice for power amplifiers because of its ability to maximize a digital cellular handset's power efficiency and battery life. Conexant has an extensive portfolio of PA products that encompasses solutions for every major wireless standard including CDMA, WCDMA, GSM, TDMA, AMPS, and wireless local loop applications.

About Conexant

Conexant Systems, Inc. is a worldwide leader in semiconductor system solutions for communications applications. Conexant leverages its expertise in mixed-signal processing to deliver integrated systems and semiconductor products through three separate businesses that address the wireless communications, broadband access and Internet infrastructure markets. Conexant's wireless communications business is focused on providing power amplifiers, radio-frequency subsystems and complete systems solutions. The broadband access business develops and delivers integrated solutions that enable digital entertainment and information networks for the home and small office. Mindspeed Technologies, the company's Internet infrastructure business, designs, develops and sells a complete portfolio of semiconductor networking solutions that facilitate the aggregation, transmission and switching of data, video and voice from the edge of the Internet to linked metropolitan area networks and long-haul networks. Conexant, headquartered in Newport Beach, Calif., delivered revenues of \$1.1 billion for fiscal 2001, and has approximately 6,900 employees worldwide. The company is a member of the S&P 500 and Nasdaq-100 indices. To learn more, visit us at www.conexant.com or www.mindspeed.com.

Safe Harbor Statement

This press release contains statements relating to future results of Conexant (including certain projections and business trends) that are "forward-looking statements" as defined in the Private Securities Litigation Reform Act of 1995. Actual results may differ materially from those projected as a result of certain risks and uncertainties. These risks and uncertainties include, but are not limited to: global economic and market conditions, such as the cyclical nature of the semiconductor industry and the markets addressed by the company's and its customers' products; demand for and market acceptance of new and existing products; successful development of new products; the timing of new product introductions; the availability and extent of utilization of manufacturing capacity; pricing pressures and other competitive factors; changes in product mix; fluctuations in manufacturing yields; product obsolescence; the ability to develop and implement new technologies and to obtain protection for the related intellectual property; the successful planned disposition of certain assets; the successful separation of the company's broadband access and Internet infrastructure businesses; the successful merger of the company's wireless communications business with Alpha Industries, Inc.; the ability to attract and retain qualified personnel; labor relations of the company, its customers and suppliers; and the uncertainties of litigation, as well as other risks and uncertainties, including but not limited to the security and safety risks of our employees and of company facilities and those risks and uncertainties detailed from time to time in the company's Securities and Exchange Commission fillings. These forward-looking statements are made only as of the date hereof, and the company undertakes no obligation to update or revise the forward-looking statements, whether as a result of new information, future events or otherwise.

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